VENUE: The conference will be held at Manipal Institute of Technology (MIT), Manipal University, Manipal, Karnataka, India. The MIT Manipal was established in the year 1957 as one of the first pioneering self-financing Engineering Colleges in the country. In 2000, it became a constituent Institute of the Deemed University - Manipal Academy of Higher Education (MAHE), which is known widely today as Manipal University. Manipal University is synonymous with excellence in higher education. With a total student intake of about 2000 per year, and around 10,000 students, over 622 faculties, over 1,000 support staff, over 26,900 alumni, MIT provides the right ambience and platform for the students’ all round development. MIT has 16 under graduate programs, 25 Masters Programs and Doctoral programs in all streams of Engineering and Science under 18 different departments. To promote Innovation, incubation and entrepreneurship, the Innovation Center at MIT houses Manipal University Technology Business Incubator and Central Instrumentation Facility. It has collaborative research programs in association with premier research laboratories and Institutes in India and abroad. The Institute has an innovative flexible syllabus based programs that involve participation of all stakeholders like management, academia, students, alumni, industry to discuss updating of the course contents in a continual process.

ABOUT MANIPAL: Situated in the state of Karnataka, Manipal is placed on a plateau between the Western Ghats and the Arabian Sea, Manipal enjoys stunning views from several locations, dotted with fascinating lakes and beaches that serve as attractive tourist points. Manipal is a small town, with simple lifestyle and picturesque surroundings. Manipal is well connected by road, rail and air. There are two main cities close to Manipal that serve as entry points, Udupi and Mangalore. Udupi is 5 kms from Manipal and Mangalore 65 kms away.

Weather: The weather is tropical and is hot with high levels of humidity between November and May. The region receives moderate to heavy rainfall between June and October.

Food: The food courts at Manipal serve a variety of cuisines like North Indian, South Indian, Chinese, Caribbean and Malaysian, plus wraps, burgers, pizzas and pasta to cater to the multi-cultural student population. Apart from the food courts, the Manipal town offers an array of restaurants with cuisines catering to the diverse student population.

Accommodation: Manipal and Udupi have good and convenient accommodation options for visitors. There is an array of hotels in Manipal and Udupi with a range of price to suit the needs of visitors.

Website:
http://acen-conference.org

Contact
Technical Matters & Visa
SSCC’17: sccc.symposium@gmail.com
SIRS’17: acn.conference@gmail.com
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Second International Conference on Applied Soft Computing and Communication Networks (ACN’17)

September 13-16, 2017
Manipal University, Karnataka, India
http://acen-conference.org

The Second International Conference on Applied Soft Computing and Communication Networks (ACN’17) provides a platform for bringing together researchers, practitioners, and academia to present and discuss ideas, challenges and potential solutions on established or emerging topics related to research and practice in applied soft computing and network communications.

This edition of ACN will be held in Manipal Institute of Technology, Manipal University, Karnataka, India during September 13-16, 2017. Manipal is a university town with beauty and natural scenery, one of the most peaceful and soothing travel destinations in India.

CALL FOR PAPERS

Prospective authors are invited to submit original unpublished work that is not currently under consideration for publication elsewhere to the following co-located symposiums at ACN’17:

- Third International Symposium on Intelligent Systems Technologies and Applications (ISTA’17) [Scopus Indexed]
- Fifth International Symposium on Security in Computing and Communications (SSCC’17) [Scopus and DBLP Indexed]
- Third International Symposium on Signal Processing and Intelligent Recognition Systems (SIRS’17) [Scopus and DBLP Indexed]

IMPORTANT DATES

Papers Due: April 30, 2017
Acceptance Notification: June 15, 2017
Final Paper Deadline: July 10, 2017
Third International Symposium on Intelligent Systems Technologies and Applications (ISTA’17)

http://www.acn-conference.org/ista2017/

ISTA’17 aims to bring together researchers in related fields to explore and discuss various aspects of intelligent systems technologies and their applications.

The following publication options are available:

- Special Issue in the Journal of Intelligent and Fuzzy Systems (JIFS), IOS Press, Netherlands (SCI Impact Factor: 1.004)
- SpringerLink, prestigious Advances in Intelligent Systems and Computing Series, Springer, Germany

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Third International Symposium on Signal Processing and Intelligent Recognition Systems (SIRS’17)


SIRS’17 aims to bring together researchers from academia, industry and government and to provide an international forum for the sharing, exchange, presentation and discussion of original research results in both methodological issues and different application areas of signal processing and pattern recognition. All accepted papers will be published by Springer in the prestigious Advances in Intelligent Systems and Computing Series. The proceedings will be available via the SpringerLink digital library.

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http://www.acn-conference.org/acn2017/

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http://www.acn-conference.org/sscc2017/

SSCC’17 aims to provide the most relevant opportunity to bring together researchers and practitioners from both academia and industry to exchange their knowledge and discuss their research findings in the area of cyber security. All accepted papers will be published by Springer in Communications in Computer and Information Science Series (CCIS). The proceedings will be available via the SpringerLink digital library.

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